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PATENT 29926/38060

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sung-Kwon Lee and Sang-Ik Kim

Serial No.: 10/066,849

Filed: February 4, 2002

For: Method for Manufacturing Multi-Level Interconnections with Dual

Damascene Process

Group Art Unit: 1756

Examiner: John S. Ruggles

I hereby certify that this paper and the documents referred to as enclosed therewith are being deposited with the United States Postal Service as first class mail, postage prepaid, on April 26, 2004, in an envelope addressed to Commissioner for Patents, P.O. Box 1450 Alexandria, Virginia 22313-1450

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AMENDMENT AFTER FINAL (37 C.F.R. § 1.116)

Mailstop AF

Commissioner for Patents

P.O. Box 1450

Alexandria, Virginia 22313-1450

Sir:

In response to the final office action mailed on February 25, 2004, please amend the above-identified patent application as follows.

Amendments to the specification begin on page 2 of this paper.

Amendments to the claims begin on page 4 of this paper.

Amendments to the abstract begin on page 7 of this paper.

Remarks begin on page 8 of this paper.